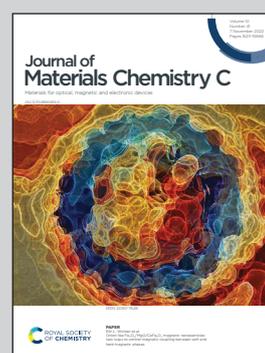


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Graphite-metal composite electrodes with a tunable
work function for use in optoelectronic devices

The graphite-metal composite electrode provides a novel
exploratory concept for tailoring the work function of
hybrid graphite materials, contributing to the performance
improvement of various photovoltaic devices.

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Graphite–metal composite electrodes with a tunable work function for use in optoelectronic devices†

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In electronic devices, the work function (WF) of the electrodes must be tailored to achieve a well-aligned Ohmic or Schottky contact. Low- and high-WF electrodes are typically used to ensure effective injection/extraction of electrons and holes. In this study, composite graphite–aluminum (G:Al) and graphite–nickel (G:Ni) electrodes were deposited on a glass substrate using electron beam evaporation, and ambient pressure photoemission spectroscopy was conducted to evaluate the WF of the fabricated electrodes. The WF of the G:Al electrode was successfully tuned from 4.24 ± 0.047 eV to 5.10 ± 0.031 eV (a range of ~ 0.9 eV) by increasing the graphite content. Similarly, the WF of the G:Ni composite electrode was tuned from 4.67 ± 0.041 eV to 5.11 ± 0.031 eV (a range of ~ 0.4 eV). The shift in the WF in the composite graphite–metal electrodes could be explained by the formation of metal–metal (or semiconductor) junctions. The optical reflectance, sheet resistance, and morphology were also able to be tuned. The sheet resistance of the G:Al and G:Ni electrodes varied from $2.28 \pm 0.03 \Omega \text{ sq}^{-1}$ to $80.05 \pm 9.1 \Omega \text{ sq}^{-1}$ and from $4.92 \pm 0.04 \Omega \text{ sq}^{-1}$ to $166.30 \pm 4.1 \Omega \text{ sq}^{-1}$, respectively, while the total tunable reflectance was 53.77% and 45.70%, respectively. This research demonstrates a novel exploratory technique for tailoring the WF of hybrid graphite materials.

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1. Introduction

The work function (WF) is a key component in the analysis of the electronic properties of materials. The WF refers to the energy needed to take an electron from the Fermi energy level (E_F) to the vacuum energy level (E_{vac}), that is, $\text{WF} = E_{\text{vac}} - E_F$. The WF of a material can be determined using thermionic emission, photoemission, field emission, and contact potential difference approaches. In addition, numerous methods have been developed to tune the WFs of electrodes,^{1–3} and these can be divided into two main categories: physical and chemical modification. Using these methods, the WF can be changed by only a few Angstroms from the surface to the bulk region. Physical methods such as the modification of the surface

roughness can help tune the WF, although only within a small range. For example, by increasing the surface roughness of materials with lightning (Cu and Ag) and anti-lightning rod (Al and Mg) effects, the WF can be decreased and increased, respectively. In particular, the weak interaction between valence electrons and nuclei on rough surfaces facilitates the escape of electrons from the surface, resulting in a low WF.⁴

The introduction of small molecules or a non-conjugated polyelectrolyte interface layer can also change the electrical field distribution between the semiconductor and the electrode. This electric field redistribution leads to Fermi level pinning, electric double-layer formation, charge transfer, spontaneous dipole orientation, spontaneous interfacial dipole orientation,⁵ electron pushback (repulsion), and interface dipole formation. These effects are associated with changes in the electrode WF. The degree of this shift in the electrode WF depends on the strength of the electric field and the choice of polyelectrolyte. Acidic and basic polyelectrolytes result in dipole formation pointing inward and outward from the electrode, leading to an increase and decrease in the WF, respectively. Nonionic polyelectrolytes do not lead to a change in the WF due to null dipole formation. Notably, chemical modification influences electrode stability in the long term.

In most electronic devices, metal electrodes such as gold, silver, copper, nickel, and aluminum are routinely used, the WF

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of which must be tuned. Alkanethiols and other polymers and small molecules are widely used to modify the WF of Au,⁶ Ag,⁷ and Cu. The self-assembled monolayer (SAM) of alkanethiol on Au can lead to a charge transfer of less than 0.05 eV. However, the thiol (R-S··H) anchor group of alkanethiol adsorbed onto the Au surface leads to the formation of Au–S bonds. This observation suggests that the WF shift is primarily associated with the dipole movement of individual molecules, while gauche defects unavoidably occur in SAMs. Compared to isolated molecules, the dipole moment decreases (known as the depolarization effect) in the SAM. However, the intensity of this effect is negligible, and it is thus not considered in many practical applications.^{8–10}

The WF of an electrode can also be modified using doping, the preparation of metal alloys, and the engineering of the crystallographic orientation. The WF of metals is an anisotropic function of the crystallographic orientation of the grains. This anisotropy is associated with the variation in the atomic packing density with the crystallographic orientation. A surface with a low atomic packing density exhibits a low WF, while a high atomic packing density leads to a high WF. The atomic packing density of many face-centered cubic (fcc) metals (Ni, Cu, and Ag) varies according to the crystallographic orientation in the following manner: $(110)_{\text{fcc}} < (001)_{\text{fcc}} < (111)_{\text{fcc}}$. Moreover, based on the crystallographic orientation, the atomic packing fraction increases in the following order: $(111)_{\text{bcc}} < (001)_{\text{bcc}} < (110)_{\text{bcc}}$. Therefore, the surface free energy is inversely related to the WF, leading to the following trend in the surface free energy for fcc and body-centered cubic (bcc) metals: $\gamma_{(110)\text{fcc}} > \gamma_{(001)\text{fcc}} > \gamma_{(111)\text{fcc}}$ and $\gamma_{(111)\text{bcc}} > \gamma_{(001)\text{bcc}} > \gamma_{(110)\text{bcc}}$. The anisotropic WF of many metals can be attributed to the presence of p- and d-orbitals, which are anisotropically distributed near the Fermi surface. For Al, the p-orbital is directionally dependent, leading to anisotropic characteristics, while s–d orbital hybridization causes anisotropy in metals such as Cu and Au. In principle, many materials exhibit an anisotropic WF due to the presence of asymmetric orbitals near the Fermi surface.^{11,12} On the other hand, the properties of graphite can be characterized by the type of hybridization of carbon in graphite (sp^3 , sp^2 , and sp^1). Higher amounts of sp^3 hybridized bonds in graphite results in diamond-like carbon, which is less conductive.

Based on these considerations, this study aimed to systematically investigate the structural, optical, morphological, and electrical properties of composite graphite–metal (graphite–aluminum [G:Al] and graphite–nickel [G:Ni]) electrodes prepared using electron beam (e-beam) evaporation. The WF of the G:Al and G:Ni electrodes was tuned by modifying the electrode composition. Using the composite electrodes, the unique physical and chemical properties of the parent materials (*i.e.*, graphite, Al, and Ni) were able to be exploited.

2. Experimental details

2.1. Materials

Graphite particles with an average particle size of ~ 8 nm ($\sim 99.9\%$), Al nanoparticles (NPs, 99.9%, 40 nm), and Ni NPs

(99.9%, 40 nm) were purchased from US Research Nanomaterials, Inc.

2.2. Preparation of the composite pellets and e-beam evaporation

The graphite particles and Al/Ni NPs were well mixed in various composition ratios to attain a homogeneous mixture. The composite materials (G:Al/G:Ni) were compressed to produce pellets, which were placed in a crucible and loaded into an e-beam chamber (e-beam evaporator model KVE-E2003L, Korean Vacuum Tech., Ltd, South Korea). The DC output voltage was set at 7 kV with a probe current of 80–100 mA. Evaporation was conducted at the pressure level of $< 5.5 \times 10^{-5}$ mbar. The electrode materials were deposited on a clean glass slide that had been sonicated for 10 min each in water, acetone, methanol, and isopropanol. The substrate temperature was maintained at room temperature (25 °C) *via* water circulation. Electrodes with a thickness of ~ 100 – 150 nm were fabricated (evaporation rate ~ 0.5 – 3.0 \AA s^{-1}). The thickness of the deposited films was evaluated using a surface profiler (KLA Tencor-Alpha-step IQ). The following samples were produced (where G denotes graphite and the number represents the % composition for that element): G1:Al9, G2:Al8, G3:Al7, G4:Al6, G5:Al5, G6:Al4, G7:Al3, G8:Al2, G9:Al1, G1:Ni9, G2:Ni8, G3:Ni7, G4:Ni6, G5:Ni5, G6:Ni4, G7:Ni3, G8:Ni2, and G9:Ni1.

2.3. Electrical and work function characterization

Four-point probe method was used to measure the sheet resistance (R_s) of the samples (area $1.5 \text{ mm} \times 1.5 \text{ mm}$). *I*–*V* measurements were conducted using a Keithley 4200A-SCS measurement system. The conductivity of the samples was measured by positioning the probes at a distance of 2 cm. The WF of the samples was measured using ambient pressure photoemission spectroscopy (APS). A high-intensity deuterium (D_2) lamp was employed to eject the photoelectrons from the electrode surface. The wavelength of the D_2 light could be tuned from 180 nm (3.4 eV) to 340 nm (7.0 eV) using a deep UV light source. To generate the photoelectrons, a circular D_2 beam was employed to illuminate the sample surface. The photoelectrons were collected by a circular (diameter ~ 2 mm) gold collector probe. To maximize the collection of the photoelectrons generated *via* D_2 illumination, a Au tip was centrally aligned with the circular UV light spot. Photoelectrons were acquired at a resolution within the contact potential difference of 0.001–0.003 eV and a WF resolution of ≤ 0.003 eV. During the measurement process, a nitrogen (purity $\sim 99.999\%$) environment was maintained. The nitrogen was purged ($\sim 60 \text{ mL s}^{-1}$) to maintain an oxygen level $< 1\%$ within the measurement chamber.

We analyzed the photocurrent/photoelectron spectra in accordance with the photon energy using the Fowler theory to determine the WF. Fowler's theory can be expressed as $R \propto (E_{\text{ph}} - h\nu_0)^2$, where R is the obtained photocurrent (electrons) per incident photon, E_{ph} is the incident photon energy, h is Planck's constant, and ν_0 is the threshold frequency. The density of states (DOS) near the Fermi energy level considerably influences the mechanical, chemical, and physical properties of

a material. To determine the DOS for the nanocomposite electrodes, the photocurrent/photoelectron intensity (Y) was plotted against the photon energy (E) was done. The plot of dY/dE against the photon energy yielded the DOS distribution.¹³

2.4. Structural, optical, and morphological characterization

The structural properties of the composite G:Al and G:Ni samples were characterized using X-ray diffraction (XRD). Diffraction measurements were taken using a Rigaku SmartLab XRD instrument. The current and voltage in the X-ray generation tube were 200 mA and 45 kV, respectively. Cu was employed as the X-ray target to induce K_{α} radiation with a wavelength of 1.54 Å. The Raman spectra of the samples were obtained using a LabRam ARAMIS IR2 system. Diode laser emitting with a center wavelength of 532 nm was used to probe the samples. The spatial resolution of the instrument was 1 μm , and the clearance between the sample and the lens system was 0.26 mm.

The absorption, transmittance, and reflectance of the neat graphite and composite graphite-Al/Ni electrodes were measured using a UV spectrometer (PerkinElmer Lambda 35). The total reflectance spectra of the composite electrodes were obtained using the UV spectrometer with an integrating sphere setup. The equation $1-R-T=A$ was used. An optical microscope (Olympus BX51M) was used to examine the composite electrode surface. Atomic force microscopy (Park Systems XE series) was employed in non-contact mode to analyze the root mean square (RMS) roughness and the surface morphology.

3. Results and discussion

3.1. Structural properties of the composite electrodes

Structural analysis. The structural properties of the G:Al and G:Ni films were examined using XRD. The neat graphite thin film had an amorphous graphite structure and exhibited a broad diffraction peak at 22° owing to the short-range crystalline order of amorphous graphite film. The crystallite size of the Al and Ni in the composite films was calculated using the Scherrer formula (eqn (1)) from the full width at half maximum (FWHM) of the (111) peak. According to the Scherrer derivation, peak broadening can be attributed to a reduction in the crystallite size and lattice-strain-induced broadening. However, the crystallite size of Al and Ni was determined by assuming that the XRD peak broadening was primarily caused by a reduction in the crystallite size; the lattice-strain-induced broadening was considered negligible. The measured FWHM (2θ) for the (111) peak and corresponding crystallite sizes for the G:Al and G:Ni composites are presented in Tables S1 and S2 (ESI[†]), respectively. A shift in the (111) peak was observed for the G:Al and G:Ni nanocomposites, indicating a modification to the lattice parameters. A larger variation in the peak shift corresponded to a larger change in lattice parameter a (eqn (2)). The calculated FWHM (2θ) and crystallite sizes of the G:Al and G:Ni electrodes are summarized in Tables S3 and S4 (ESI[†]), respectively. The XRD spectra (10 – 90°) for the G:Al and G:Ni composite electrodes are presented in Fig. 1a and b, respectively.

$$t = \frac{K \times \lambda}{\beta \times \cos \theta} \quad (1)$$

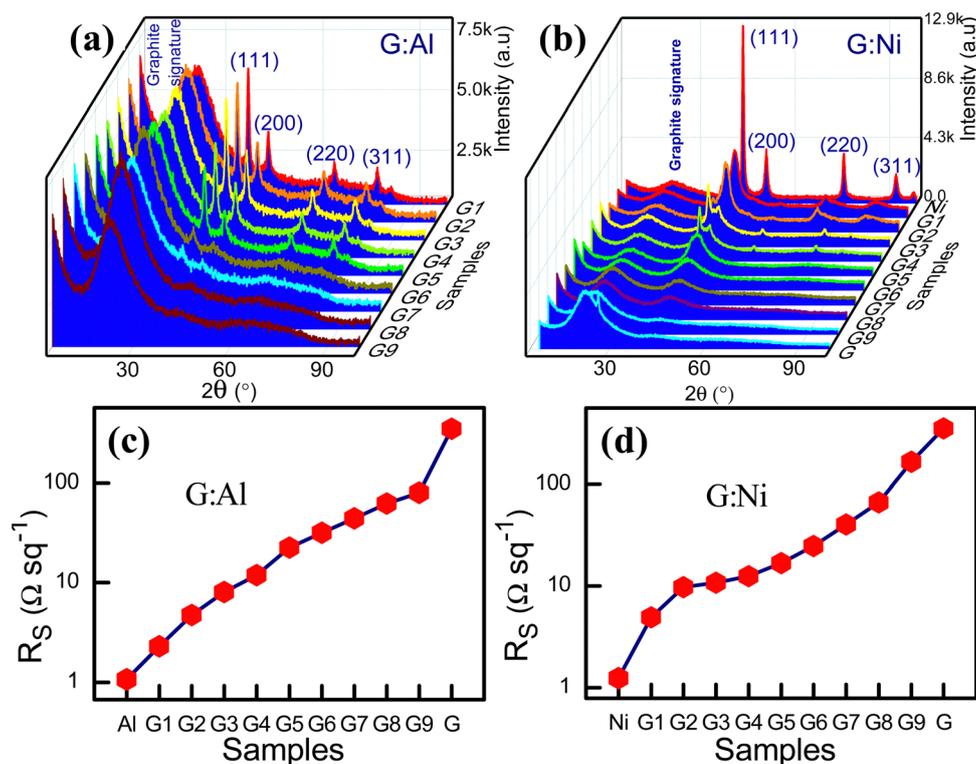


Fig. 1 XRD spectra for the composite (a) G:Al and (b) G:Ni electrodes. Sheet resistance for the (c) G:Al and (d) G:Ni electrodes on a log scale.

$$2a \times \sin \theta = n\lambda \sqrt{h^2 + k^2 + l^2} \quad (2)$$

where t is the calculated crystallite size, which primarily depends on the line broadening at the FWHM (β), and θ ($^\circ$) is the diffraction angle of the (111) peak. The crystalline and amorphous fraction percentages for the G:Al and G:Ni electrodes were quantified using eqn (3) and (4), respectively:^{14–16}

$$\text{Amorphous fraction (in\%)} = \left(\frac{I_{\text{Amorph}}}{I_{\text{Total}}} \right) \times 100\% \quad (3)$$

$$\text{Crystalline fraction (in\%)} = \left(\frac{I_{\text{Cryst}}}{I_{\text{Total}}} \right) \times 100\% \quad (4)$$

where I_{Cryst} and I_{Amorph} are the crystalline and amorphous peak intensities, respectively (Fig. S1a and b, ESI[†]). The dominant peaks for the pure Al (fcc) electrode were (111), (200), (220), and (311). As the graphite content increased in the composite G:Al electrodes, the diffraction intensity of these planes decreased. The diffraction peaks at 38.5°, 44.74°, and 65.13° were indicative of the fcc structure of the Al phase.¹⁷ However, the (111) peak positions shifted to higher 2θ values as the graphite content increased in the G:Al composite (from 38.5° for Al to 38.6523° for G5:Al5). According to eqn (2), a larger 2θ corresponds to a smaller lattice constant a . In addition, the FWHM also increased as the graphite content in the composite electrode increased (from 0.7553 for G1:Al9 to 0.9507 for G5:Al5). In other words, the Al crystallite size decreased with an increasing graphite content (from 11.65 nm for G1:Al9 to 9.25 nm for G5:Al5). A smaller ratio of Al in the G:Al source corresponded to a lower Al vapor density and growth rate, resulting in a smaller crystallite size. Regardless of the G:Al ratio, the intensity of the diffraction peaks had the following order: (111) > (200) > (220) > (311). A broad diffraction peak was also observed at a 2θ angle of 22° due to the random presence of short-range ordering in the graphite and the contribution of the Al grain boundaries (Fig. 1a).¹⁸ As the graphite content increased in the G:Al composite, both interplanar spacing b and lattice constant a decreased (Table S3, ESI[†]), suggesting a contraction in the unit cell volume.

Fig. 1b displays the XRD spectra for the G:Ni electrodes and Ni (fcc). The calculated 2θ , FWHM, and crystallite size for these electrodes are also presented in Table S4 (ESI[†]), and the variation with respect to the graphite content is shown in Fig. S2a–c (ESI[†]). As the graphite content increased, the 2θ of the (111) peak shifted to lower values (from 45.02° for Ni to 43.68° for G8:Ni2). This decrease in 2θ of $\sim 1.34^\circ$ was related to an increase in the lattice constant a for Ni (eqn (2)), which indirectly indicated a change in the unit cell volume (V). The FWHM of Ni and G8:Ni2 was 0.66° and 6.29°, respectively, demonstrating that the crystallite size for G8:Ni2 (1.4 nm) was smaller than that for the Ni (13.5 nm) electrode. The variation in 2θ , FWHM, and crystallite size according to the G:Ni ratio is presented in Fig. S2d–f (ESI[†]). The variation in the lattice constant and the interplanar spacing was calculated for the composite electrodes (Table S4, ESI[†]). For the G:Ni electrodes, as the graphite content increased, both interplanar spacing d and the lattice constant a increased.

Raman spectroscopy. Raman spectroscopy is a powerful, nondestructive technique for the analysis of carbon materials. In particular, this approach is widely used to investigate the properties of crystalline, semi-crystalline, and amorphous graphite materials.¹⁹ The fabricated amorphous graphite thin film exhibited two signature modes at 1350 cm^{-1} (D-band) and 1600 cm^{-1} (G-band). In general, the intensity ratio of the D- and G-bands represents the conductivity of the thin film. In pristine graphite, the G-band tends to be very intense (*i.e.*, a high sp^2 content), whereas the D-band is generally active when graphene is disordered. The D/G-band ratio of the peak intensities for the composite was not higher than that of pristine graphene, suggesting that the disorder did not significantly increase in the presence of Al and Ni crystallites (Fig. S3a and b, ESI[†]).^{20,21}

3.2. Electrical properties of the composite electrodes

Sheet resistance. The electrical properties of the composite electrodes were investigated using four-point probe R_s and I - V measurements. For each electrode composition, the I - V measurements were obtained from 10 different samples to assess the uniformity of the sheet resistance and the associated error (Table S1, ESI[†]). The sheet resistance for Al and graphite was $1.067 \pm 0.01 \Omega \text{ sq}^{-1}$ (d : $137.5 \pm 3.2 \text{ nm}$) and $352.2 \pm 4.64 \Omega \text{ sq}^{-1}$ (d : $147.8 \pm 7.4 \text{ nm}$), respectively. As the graphite content increased from G1 to G9 in the G:Al composites, the sheet resistance increased due to the low conductivity of graphite. The sheet resistance of the G:Al composites was between that for Al and graphite ($2.284 \pm 0.03 \Omega \text{ sq}^{-1}$ for G1:Al9 and $80.052 \pm 9.11 \Omega \text{ sq}^{-1}$ for G9:Al1). The sheet resistance of the composite G:Al electrode could be tuned by $\sim 78 \Omega \text{ sq}^{-1}$. The electrode with 10% Al and 90% graphite had a 77% lower sheet resistance than that of pure graphite. In contrast, the electrode with 10% graphite and 90% Al had a 50% higher sheet resistance.^{22,23} The variation in the sheet resistance according to the Al and Ni content is presented in Fig. 1c and d, respectively. The I - V characteristics (Fig. S4a and b, ESI[†]) and conductivity (Fig. S4c and d, ESI[†]) of the G:Al and G:Ni electrodes are also plotted.

Due to the mechanisms described above, the addition of graphite to the Ni electrode led to an increased R_s . The sheet resistance of various G:Ni composite electrode is presented in Table S2 (ESI[†]). The pure Ni electrode exhibited a sheet resistance of $1.244 \pm 0.005 \Omega \text{ sq}^{-1}$ (d : $119.1 \pm 11 \text{ nm}$), while the composite electrodes had a sheet resistance range of $161 \Omega \text{ sq}^{-1}$ (from $4.903 \pm 0.043 \Omega \text{ sq}^{-1}$ for G1:Ni9 to $166.3 \pm 4.101 \Omega \text{ sq}^{-1}$ for G9:Ni1). For the G:Al and G:Ni electrodes, regardless of their surface defects or porosity, the sheet resistance increased with increasing graphite content due to the low conductivity of graphite. The electrical resistivity (eqn (5)) and conductivity (eqn (6)) were determined using R_s , while the factors influencing the DC conductivity of the G:Al and G:Ni composite electrodes are summarized in eqn (7).

$$\rho = R_s d \quad (5)$$

$$\sigma = \frac{1}{\rho} \quad (6)$$

$$\sigma_{dc} = e \int g(E) \cdot \mu(E) \cdot f(E) [1 - f(E)] dE \quad (7)$$

where ρ is the electrical resistivity. d , σ , and σ_{dc} denote the film thickness, electrical conductivity, and DC electrical conductivity, respectively. In eqn (7), $g(E)$, $\mu(E)$ and $f(E)$ denote the density of localized tail states, the energy-dependent electronic mobility, and the Fermi distribution function of the electrons, respectively. The DC electrical conductivity is the integral function of $g(E)$, $\mu(E)$ and $f(E)$ (eqn (7)).^{24–30}

WF measurement. The WF of the composite electrodes was determined using APS¹⁶ (Fig. S5, ESI[†]). The WF was calculated without considering any roughness-induced change. With an increase of approximately ~ 100 nm in the RMS roughness, the WF increased by approximately 0.06 eV and 0.05 eV for Cu and Ag, respectively.⁴ For the G:Al and G:Ni electrodes, the total

variation in the RMS roughness was 0.32–5.26 nm and 0.22–1.40 nm, respectively.

In general, charge transfer is a spontaneous process that occurs at any interface between two materials that are in contact (metals, semiconductors, or insulators). The charge transfer mechanism across the G:Al and G:Ni interfaces and the change in the WF in these composite electrodes can be understood in terms of metal–metal (or semiconductor) junction formation and the associated band energy structure (Fig. S6a–e, ESI[†]). Metal–metal junctions are usually formed between two conducting materials. When a metal–metal (or semiconductor) Ohmic contact is formed between materials with dissimilar WFs, a contact potential is generated. Electrons in the low-WF metal tunnel into the high-WF metal until the Fermi level of both metals is similar at equilibrium (*i.e.*, no external bias at a given

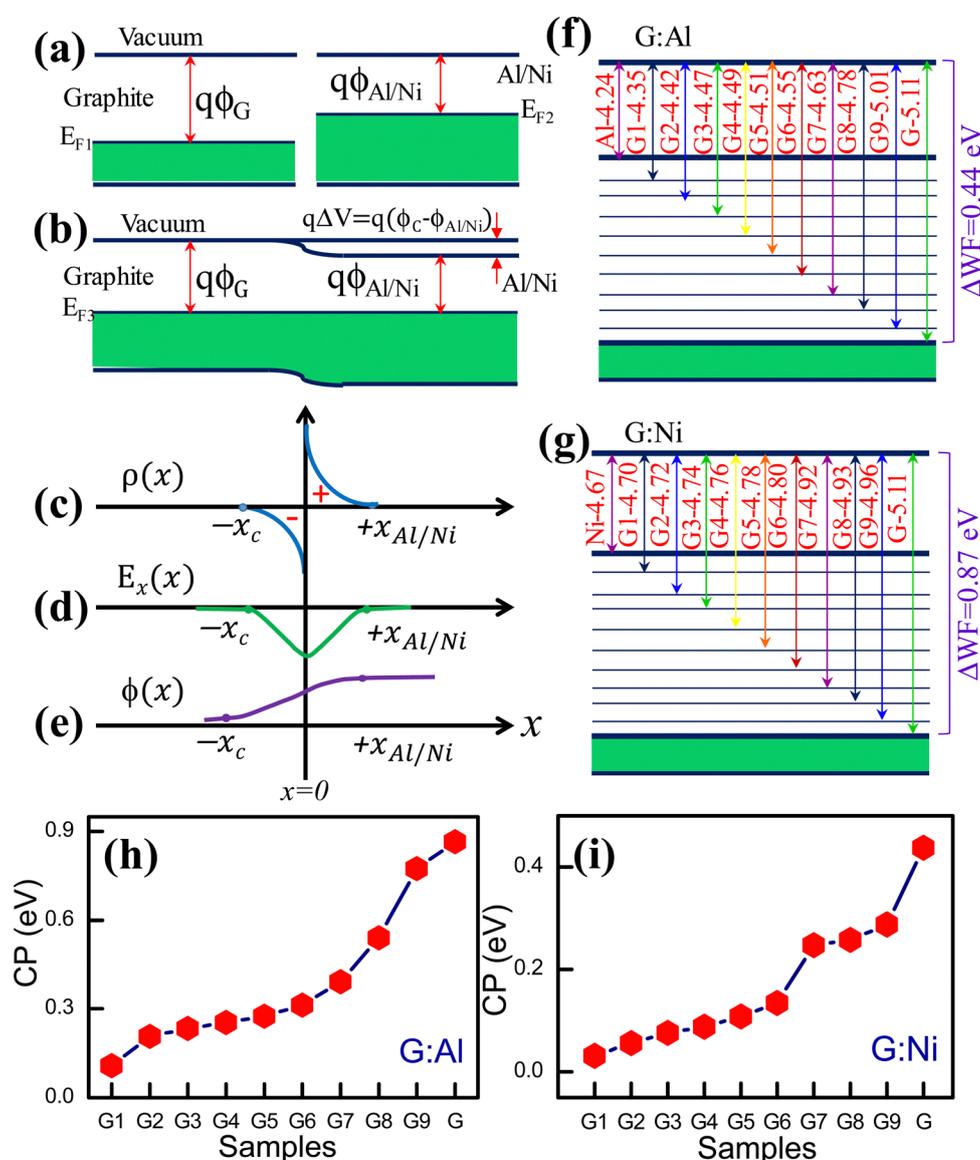


Fig. 2 Graphite–Al/Ni composites (a) before and (b) after junction formation. (c) Space charge density distribution, (d) electric field distribution, (e) electric potential at the junction. WF of various composite (f) G:Al and (g) G:Ni electrodes and the contact potential (CP) of (h) G:Al and (i) G:Ni electrodes.

temperature). The electrons from the high-WF metal also flow to the low-WF metal and occupy empty energy levels, resulting in a minimum Helmholtz free energy. At equilibrium, a new E_F is generated that differs from that of the individual metals. This process results in a positive pole in the high-WF metal and a negative pole in the low-WF metal. Consequently, at equilibrium, a contact potential is generated between the metals, the magnitude of which depends on the difference in the WF of the contacting metals.^{31,32} Fig. 2a and b present a schematic overview of the graphite–Al/Ni system before and after junction formation, respectively. Similarly, Fig. 2c–e display the charge density distribution, electric field distribution, and electric potential at the junction, respectively. The change in the WF of the composite electrodes according to the graphite content is shown in Fig. 2f and g, respectively. In both cases, the WF increased as the graphite content increased in the G:Al and G:Ni electrodes. The difference in WF between the electrodes can be explained by the formation of metal–metal (or semiconductor) Ohmic junctions. The WF of the neat Al and graphite electrodes was 4.24 ± 0.047 eV and 5.10 ± 0.031 eV, respectively (Fig. 2f). In the G:Al composites, however, the electrons flowed from Al to the graphite, thus generating a new Fermi level that depended on the ratio of Al and graphite.

The Fermi level alignment in these composites can also be explained based on the graphite and Al phase distributions within the composite film. The phase distributions can be divided into three categories: (i) low graphite content, (ii) low Al (or high graphite) content, and (iii) an equal ratio of graphite and Al. In the electrodes with a low graphite content, such as

G1:Al9 (4.353 eV), G2:Al8 (4.421 eV), G3:Al7 (4.478 eV), and G4:Al6 (4.499 eV) (Table S1, ESI[†]), a larger region is covered by the Al phase and an extremely small region is occupied by graphite. In this configuration, the graphite is assumed to be embedded in the Al matrix like a series of islands (Fig. S7, ESI[†]), which generates more electron-donating states (*i.e.*, the graphite boundary area) and fewer electron-accepting empty states (*i.e.*, the Al boundary area). Therefore, only some of the electrons from Al can tunnel into the low-energy states of graphite at equilibrium. Nanoscale metal–metal (or semiconductor) Ohmic junctions form, followed by electron transfer. In other words, the volume fraction of the active interfacial area across the graphite and Al is low, thus only a marginal change in the WF is observed for the electrodes with a low Al content.

The change in the contact potential (ΔV) for the G1:Al9, G2:Al8, G3:Al7, G4:Al6, G5:Al5, G6:Al4, G7:Al3, G8:Al2, G9:Al1 and G electrodes is presented in Fig. 2h. The actual contact potential between graphite and Al is ~ 0.9 eV, whereas the contact potential for the composites was less than this. A similar charge transfer mechanism was expected to occur in the G:Ni composite electrode. Fig. 2g and i show the difference in the WF and contact potential, respectively, between the G:Ni composite electrodes. The measured WF for the pristine Ni and graphite electrodes was 4.673 ± 0.041 eV and 5.111 ± 0.031 eV, respectively. For the C:Ni composite electrode system, the contact potential (ΔV) and tunable WF range was approximately 0.5 eV. In principle, the volume fraction of the active interfacial boundary formed between graphite and Ni dictated the change in the WF.

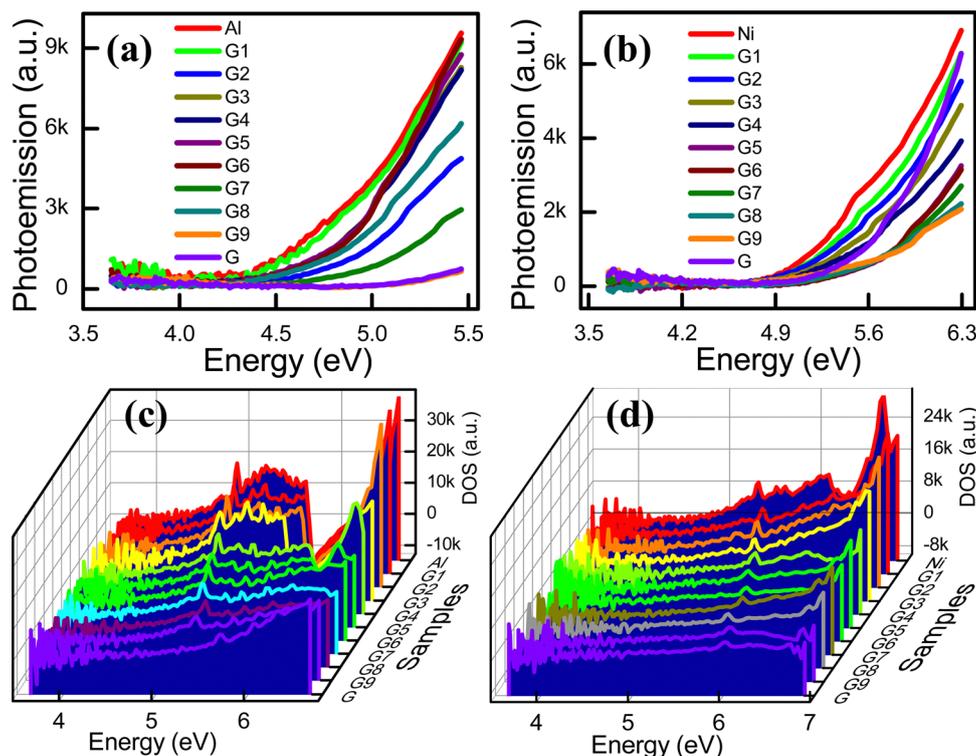


Fig. 3 Photoemission spectra of the (a) G:Al and (b) G:Ni electrodes. Local density of states of the (c) G:Al and (d) G:Ni electrodes.

The LDOS, which is the DOS primarily associated with the valence band electrons, is the number of electronic states present in the unit energy range. The energy distribution and carrier concentration can be obtained from the DOS. The LDOS near the Fermi energy level of materials considerably influences the physical and chemical properties of a material.¹³ In this study, the LDOS was derived from the wavelength-dependent photoelectron emission spectra of the composite electrodes. Fig. 3a and b present the photoemission spectra for the G:Al and G:Ni electrodes, respectively, while the local DOS (LDOS; the valence band DOS) of the G:Al and G:Ni electrodes is presented in Fig. 3c and d, respectively, with the specific values summarized in Table S5 (ESI[†]). As the graphite content in the G:Al and G:Ni electrodes increased, the LDOS state decreased. The LDOS corresponding to the Fermi energy is the LDOS that is associated with the energy in the LDOS state plot. Thus, the DOS corresponding to the Fermi energy can be estimated based on the *x*-axis on the LDOS plot. The spectra for the variation in the integrated LDOS with the energy for the G:Al and G:Ni electrodes are displayed in Fig. S8a and b (ESI[†]), respectively, while the composition-dependent LDOS for the G:Al and G:Ni electrodes are presented in Fig. S8c and d (ESI[†]), respectively.

3.3. Optical properties of the composite electrodes

The total reflectance of the hybrid electrodes was measured in the 200–1000 nm wavelength range (Fig. 4). The pristine Al electrode (~78.73%R) exhibited a higher reflectance than the neat graphite (~24.96%R) electrode. Therefore, in the composite G:Al electrodes, the total possible tunable reflectance (Δ %R) was ~49.77%R. A target %R within this range can be achieved using a hybrid electrode with a suitable G:Al composition. Specifically, by increasing the graphite or Al content in the G:Al electrodes, %R can be decreased or increased, respectively. The reflectance spectra of the G:Al electrodes with various graphite to Al ratios are presented in Fig. 4a. For the neat Ni electrode, the reflectance was 70.66%R, while the tunable range for %R for a 100 nm-thick G:Ni electrode was approximately 45.7%R. The neat Ni electrode exhibited a higher reflectance than the neat G electrode (24.96%R). By increasing the graphite and Ni content in the G:Ni composite electrode, the %R can be decreased and increased, respectively (Fig. 4b).³³ The average reflectance for the G:Al and G:Ni electrodes with increasing graphite content

is presented in Fig. S9a and b (ESI[†]), respectively, while the plasmonic absorption of the G9:Al1 sample is presented in Fig. S9c (ESI[†]).

3.4. Morphology of the composite electrodes

The surface morphology of the G:Al and G:Ni electrodes was examined using optical micrographs and AFM. The optical micrographs were taken at a magnification of 5X. The surface texture of the Al and Ni electrodes was flat and it appeared to be free of pinholes. For both types of electrode, the number of pinholes increased with increasing graphite content. Furthermore, as the graphite content increased in the G:Al/G:Ni electrodes, the graphite phase grew, shown in the optical micrographs as a dark region. This increase in the dark phase suggests an increased domain size for graphite. In addition, island-type growth was observed in the films with high graphite levels of G:Al and G:Ni (Fig. S7, ESI[†]), while the distribution of graphite in the G:Al/G:Ni electrodes (black: graphite; gray: Al/Ni), with low (Fig. S6a, ESI[†]), medium (Fig. S6b, ESI[†]) and high graphite content (Fig. S6c, ESI[†]) is also schematically illustrated. Fig. S6d (ESI[†]) presents a close view of the schematic representation of the G:Al/G:Ni interface and Fig. S6e (ESI[†]) presents the Fermi energy and WF of Al, Ni, and G.

The surface morphology and RMS roughness of the G:Al and G:Ni electrodes were also examined using AFM in non-contact mode (Fig. 5). As the Al content in the G:Al electrodes increased, larger grains appeared on the surface (Fig. 5: G1:Al9, G2:Al8, G3:Al7, G4:Al6, G5:Al5, G6:Al4, G7:Al3, G8:Al2, G9:Al1). Though the RMS roughness of the G:Al electrodes varied with the Al content, the maximum roughness was 10 nm (Fig. S10a, ESI[†]). The average thickness of the G:Al and G:Ni electrodes is presented in Fig. S10c and d (ESI[†]). The difference in the crystallite size for the G:Al electrodes is summarized in Table S3 (ESI[†]). Similar trends were also noted for the G:Ni composite electrode (Fig. 5: G1:Ni9, G2:Ni8, G3:Ni7, G4:Ni6, G5:Ni5, G6:Ni4, G7:Ni3, G8:Ni2, G9:Ni1). In the composite G:Al/G:Ni electrodes, the graphite was amorphous in nature, whereas Al and Ni were in crystalline form. The difference in the crystallite size for the G:Ni electrodes is given in Table S4 (ESI[†]), while the RMS roughness obtained from AFM is listed in Table S1 and S2 (ESI[†]). Fig. S10b (ESI[†]) displays the average RMS roughness for the G:Ni electrodes and AFM images of the

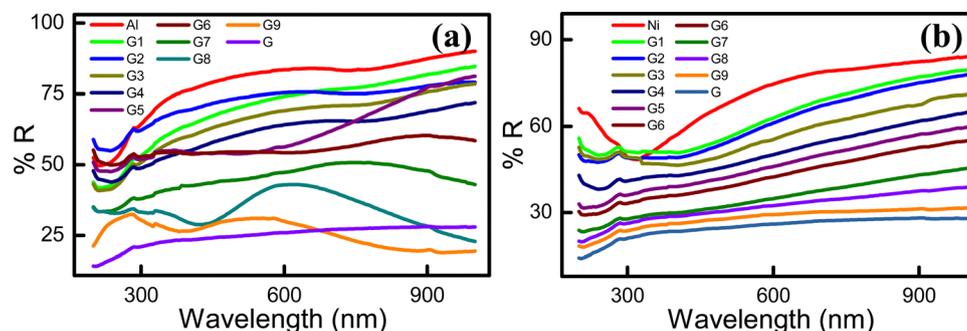


Fig. 4 Optical reflectance spectra of (a) G:Al and (b) G:Ni electrodes.

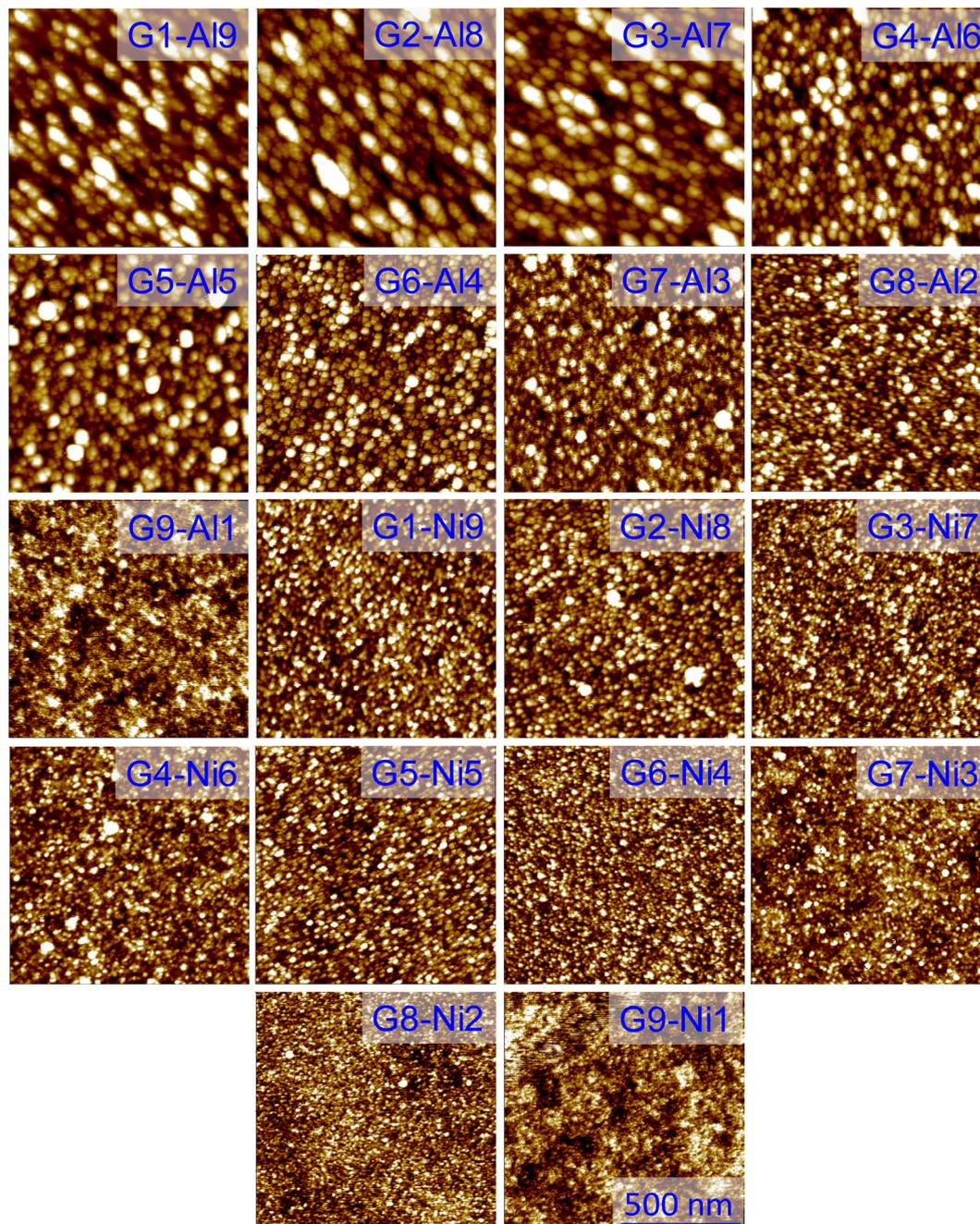


Fig. 5 Surface topography (area: $1 \times 1 \mu\text{m}$) of the G:Al and G:Ni electrodes measured using AFM in noncontact mode.

Ni electrode, Al electrode and graphite film are presented in Fig. S11 (ESI[†]).

4. Conclusions

G:Al and G:Ni composites were deposited on a glass substrate using e-beam evaporation. The WF of the G:Al and G:Ni electrodes and their associated structural, optical, electrical, and morphological properties were investigated. The difference in the WF of the electrodes with different graphite content was

examined. In calculating the WF, roughness was ignored because it was less than 10 nm. The WF for the G:Al and G:Ni electrodes could be tuned from 4.20 eV to 5.10 eV and from 4.67 eV to 5.10 eV, respectively, due to the formation of graphite-metal (Al/Ni) Ohmic contacts. The resistivity of the G1:Al9 and G1:Ni9 electrodes decreased from $352 \Omega \text{ sq}^{-1}$ to $2.284 \pm 0.03 \Omega \text{ sq}^{-1}$ and from $4.903 \pm 0.043 \Omega \text{ sq}^{-1}$, respectively. As the Al or Ni content increased, the reflectance increased. The reflectance of the graphite thin film was 28.04%, and that of the G1:Al9 and G1:Ni9 electrodes was 72.07% and 63.24%, respectively. As expected, the addition of

metal NPs to a graphite composite film increased the optical reflectance. This proposed graphite–metal composite electrode can be utilized in photovoltaic applications that require a low cost, a high work function, and low-reflection anodes.

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Conflicts of interest

The authors declare no competing financial interests.

References

- 1 M. Seong, H. Kim, S. W. Lee, D. Kim and S. J. Oh, *APL Mater.*, 2018, **6**, 121105.
- 2 C. Tian, A. Mei, S. Zhang, H. Tian, S. Liu, F. Qin, Y. Xiong, Y. Rong, Y. Hu and Y. Zhou, *Nano Energy*, 2018, **53**, 160–167.
- 3 J. W. Kim and A. Kim, *Curr. Appl. Phys.*, 2021, **31**, 52–59.
- 4 M. Xue, W. Wang, F. Wang, J. Ou, C. Li and W. Li, *J. Alloys Compd.*, 2013, **577**, 1–5.
- 5 B. H. Lee, I. H. Jung, H. Y. Woo, H. K. Shim, G. Kim and K. Lee, *Adv. Funct. Mater.*, 2014, **24**, 1100–1108.
- 6 D. B. Bert, A. Hadipour, M. M. Mandoc, T. Woudenberg and P. W. Blom, *Adv. Mater.*, 2005, **17**, 621–625.
- 7 I. Campbell, S. Rubin, T. Zawodzinski, J. Kress, R. Martin, D. Smith, N. Barashkov and J. Ferraris, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1996, **54**, R14321.
- 8 D. Cornil, Y. Olivier, V. Geskin and J. Cornil, *Adv. Funct. Mater.*, 2007, **17**, 1143–1148.
- 9 H. Lu, Z. Liu, X. Yan, D. Li, L. Parent and H. Tian, *Sci. Rep.*, 2016, **6**, 1.
- 10 S. A. Sergiienko, D. M. Tobaldi, L. Lajaunie, D. V. Lopes, G. Constantinescu, A. L. Shaula and N. D. Shcherban, *J. Mater. Chem. C*, 2022, **10**, 626–639.
- 11 L. Gao, J. Souto-Casares, J. R. Chelikowsky and A. A. Demkov, *J. Chem. Phys.*, 2017, **147**, 214301.
- 12 D. Wu, S. Wan, T. Zhai, J. Yang, R. Wang and S. Duhm, *Phys. Status Solidi RRL*, 2022, **16**, 2100434.
- 13 A. V. Kesavan, B. R. Lee, K. R. Son, A. C. Khot, T. D. Dongale, V. Murugadoss, P. C. Ramamurthy and T. G. Kim, *ACS Appl. Mater. Interfaces*, 2021, **13**, 4284.
- 14 D. S. Kang, S. M. Lee, S. H. Lee and J. S. Roh, *Carbon Lett.*, 2018, **27**, 108–111.
- 15 S. Krimm, *J. Phys. Chem.*, 1953, **57**, 22–25.
- 16 S. Krimm and A. V. Tobolsky, *J. Polym. Sci.*, 1951, **7**, 57–76.
- 17 M. Rashad, F. Pan, A. Tang and M. Asif, *Prog. Nat. Sci.: Mater. Int.*, 2014, **24**, 101.
- 18 A. Jabbar, G. Yasin, W. Q. Khan, M. Y. Anwar, R. M. Korai, M. N. Nizam and G. Muhyodin, *RSC Adv.*, 2017, **7**, 31100–31109.
- 19 I. R. M. Kottegoda, N. H. Idris, L. Lu, J. Z. Wang and H. K. Liu, *Electrochim. Acta*, 2011, **56**, 5815–5822.
- 20 J. Robertson, *Philos. Mag. B*, 1997, **76**, 335–350.
- 21 A. Taylor, S. Baluchová, L. Fekete, L. Klimša, J. Kopeček, D. Šimek, M. Vondráček, L. Míka, J. Fischer, K. Schwarzová-Pecková and V. Mortet, *Diamond Relat. Mater.*, 2022, **123**, 108815.
- 22 V. V. Brus, M. I. Ilashchuk, I. G. Orletskyi, M. M. Solovan, G. P. Parkhomenko, I. S. Babichuk, N. Schopp, G. O. Andrushchak, A. I. Mostovyi and P. D. Maryanchuk, *Nanotechnology*, 2020, **31**, 505706.
- 23 K. P. Maity and V. Prasad, *Mater. Res. Express*, 2019, **6**, 0850a2.
- 24 M. Brohmann, F. J. Berger, M. Matthiesen, S. P. Schießl, S. Schneider and J. Zaumseil, *ACS Nano*, 2019, **13**, 7323–7332.
- 25 C. Godet, *Philos. Mag. B*, 2001, **81**, 205–222.
- 26 D. Dasgupta, F. Demichelis and A. Tagliaferro, *Philos. Mag. B*, 1991, **63**, 1255–1266.
- 27 N. F. Mott, *Philos. Mag.*, 1969, **19**, 835–852.
- 28 I. G. Austin and N. F. Mott, *Adv. Phys.*, 1969, **18**, 41.
- 29 M. Chen, W. Li, A. Kumar, G. Li, M. E. Itkis, B. M. Wong and E. Bekyarova, *ACS Appl. Mater. Interfaces*, 2019, **11**, 19315–19323.
- 30 T. Brintlinger, M. S. Fuhrer, J. Melngailis, I. Utke, T. Bret, A. Perentes, P. Hoffmann, M. Abourida and P. Doppelt, *J. Vac. Sci. Technol.*, 2005, **23**, 3174–3177.
- 31 A. Datta, P. Becla and S. Motakef, *Sci. Rep.*, 2019, **9**, 1.
- 32 I. F. Patai and M. A. Pomerantz, *J. Franklin Inst.*, 1951, **252**, 239–260.
- 33 K. H. Lee, W. K. Seong and R. S. Ruoff, *Carbon*, 2022, **187**, 396–403.